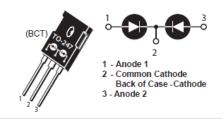


## MSC050SDA120BCT Zero Recovery Silicon Carbide Schottky Dual Diode

#### **Product Overview**

The silicon carbide (SiC) power Schottky barrier diodes (SBD) product line from Microsemi increases your performance over silicon diode solutions while lowering your total cost of ownership for high-voltage applications. The MSC050SDA120BCT is a 1200 V, 50 A SiC dual common cathode SBD in a three-lead TO-247 package shown below.



#### **Features**

The following are key features of the MSC050SDA120BCT device:

- No reverse recovery
- · Low forward voltage
- Low leakage current
- · Avalanche energy rated
- RoHS compliant

#### **Benefits**

The following are benefits of the MSC050SDA120BCT device:

- · High switching frequency
- Low switching losses
- Low noise (EMI) switching
- · Higher reliability systems
- · Increased system power density

#### **Applications**

The MSC050SDA120BCT device is designed for the following applications:

- Power factor correction (PFC)
- Anti-parallel diode
  - Switch-mode power supply
  - Inverters/converters
  - Motor controllers
- · Freewheeling diode
  - Switch-mode power supply
  - Inverters/converters
- · Snubber/clamp diode



## **Device Specifications**

This section details the specifications for the MSC050SDA120BCT device. All ratings are per leg.

### **Absolute Maximum Ratings**

The following table shows the absolute maximum ratings for the MSC050SDA120BCT device. All ratings at  $T_C = 25$  °C unless otherwise specified.

**Table 1 • Absolute Maximum Ratings** 

Sym- bol	Parameter		Ratings	Unit
V <sub>R</sub>	Maximum DC reverse voltage		1200	V
V <sub>RRM</sub>	Maximum peak repetitive reverse voltage			
V <sub>RWM</sub>	Maximum working peak reverse voltage			
I <sub>F</sub>	I <sub>F</sub> Maximum DC forward current		109	А
		T <sub>C</sub> = 135 °C	49	
		T <sub>C</sub> = 145 °C	41	
I <sub>FRM</sub>	Repetitive peak forward surge current ( $T_C = 25$ °C, $t_p = 8.3$ ms, half sine wave)		154	
I <sub>FSM</sub>	Non-repetitive forward surge current ( $T_C = 25  ^{\circ}C$ , $t_p = 8.3  \text{ms}$ , half sine wave)		290	
P <sub>tot</sub>	Power dissipation	T <sub>C</sub> = 25 °C	429	W
		T <sub>C</sub> = 110 °C	186	
T <sub>J</sub> , T <sub>ST-</sub>	Operating junction and storage temperature range		-55 to 175	°C
T <sub>L</sub>	Lead temperature for 10 seconds		300	
E <sub>AS</sub>	Single-pulse avalanche energy (starting $T_J$ = 25 °C, L = 0.08 mH, peak $I_L$ = 50 A)		100	mJ

The following table shows the thermal and mechanical characteristics of the MSC050SDA120BCT device.

Table 2 • Thermal and Mechanical Characteristics

Symbol	Characteristic	Min	Тур	Max	Unit
$R_{\theta JC}$	Junction-to-case thermal resistance		0.24	0.35	°C/W
W <sub>T</sub>	Package weight		0.22		OZ



Symbol	Characteristic	Min	Тур	Max	Unit
			5.9		g
	Maximum mount- ing torque			10	lbf-in
				1.1	N-m

### **Electrical Performance**

The following table shows the static characteristics of the MSC050SDA120BCT device.

**Table 3 • Static Characteristics** 

Symbol	Characteristic/Test Conditions		Min	Тур	Max	Unit
V <sub>F</sub>	Forward voltage	I <sub>F</sub> = 50 A, T <sub>J</sub> = 25 °C		1.5	1.8	V
		I <sub>F</sub> = 50 A, T <sub>J</sub> = 175 °C		2.1		
I <sub>RM</sub>	I <sub>RM</sub> Reverse leakage current	V <sub>R</sub> = 1200 V, T <sub>J</sub> = 25 °C		15	200	μА
		V <sub>R</sub> = 1200 V, T <sub>J</sub> = 175 °C		250		
Q <sub>C</sub>	Total capacitive charge $V_R = 600 \text{ V}$ , $T_J = 25 \text{ °C}$			224		nC
C <sub>J</sub>	Junction capacitance $V_R = 400 \text{ V}$ , $T_J = 25 ^{\circ}\text{C}$ , $f = 1 ^{\circ}\text{MHz}$			246		pF
	Junction capacitance V <sub>R</sub> = 800		182			



### **Performance Curves**

This section shows the typical performance curves for the MSC050SDA120BCT device.

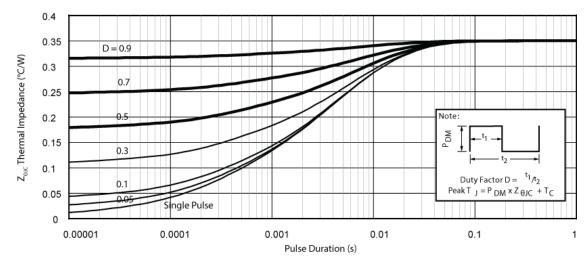
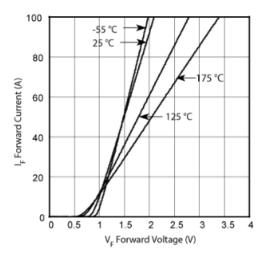


Figure 1 • Maximum Transient Thermal Impedance



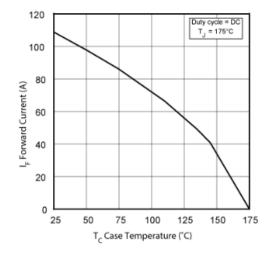


Figure 2 • Forward Current vs. Forward Voltage

Figure 3 • Max Forward Current vs. Case Temp



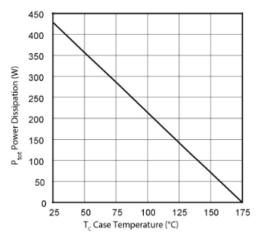


Figure 4 • Max Power Dissipation vs. Case Temp

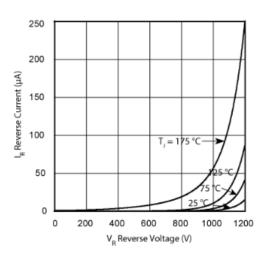


Figure 5 • Reverse Current vs. Reverse Voltage

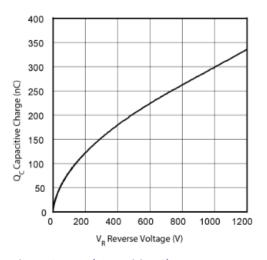


Figure 6 ● Total Capacitive Charge vs. V<sub>R</sub>

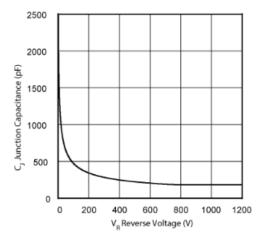


Figure 7 • Junction Capacitance vs. V<sub>R</sub>



## **Package Specification**

This section outlines the package specification for the MSC050SDA120BCT device.

### **Package Outline Drawing**

This section details the TO-247 package drawing of the MSC050SDA120BCT device. Dimensions are in millimeters and (inches).

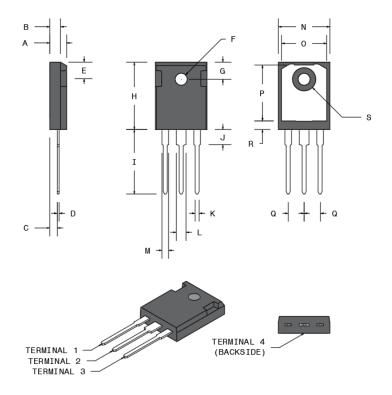


Figure 8 • Package Outline Drawing

The following table shows the TO-247 dimensions and should be used in conjunction with the package outline drawing.

Table 4 • Dimensions

Symbol	Min. (mm)	Max. (mm)	Min. (in.)	Max (in.)
А	4.69	5.31	0.185	0.209
В	1.49	2.49	0.059	0.098
С	2.21	2.59	0.087	0.102
D	0.40	0.79	0.016	0.031
Е	5.38	6.20	0.212	0.244
F	3.50	3.81	0.138	0.150



Symbol	Min. (mm)	Max. (mm)	Min. (in.)	Max (in.)	
G	6.15 BSC		0.242 BSC		
Н	20.80	21.46	0.819	0.845	
I	19.81	20.32	0.780	0.800	
J	4.00	4.50	0.157	0.177	
К	1.01	1.40	0.040	0.055	
L	2.87	3.12	0.113	0.123	
M	1.65	2.13	0.065	0.084	
N	15.49	16.26	0.610	0.640	
0	13.50	14.50	0.531	0.571	
Р	16.50	17.50	0.650	0.689	
Q	5.45 BSC		0.215 BSC		
R	2.00	2.75	0.079	0.108	
S	7.10	7.50	0.280	0.295	
Terminal 1	Anode 1				
Terminal 2	Common cathode				
Terminal 3	Anode 2				
Terminal 4	Common cathode				





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